## **Supporting Information**

# **Construction of Nano-Lamellar Expressways and Multidimensional Defects Realizes the Decoupling of Carrier-Phonon Transport in BiSbSe1.25Te1.75**

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#### **Experimental details**

**Material synthesis**: High-purity elemental chunks of Bi, Sb, Se and Te with >99.999% were weighed based on the stoichiometric ratio of  $BiSbSe<sub>1.25</sub>Te<sub>1.75</sub>$  and sealed in a quartz tube of  $10^{-3}$  Pa for the solid-phase reaction. The tube was placed into box furnace, then slowly heated up to 1273 K and soaked at 1273 K for 6 h. The obtained ingot was ground into powders using an agate mortar, and then hot pressed at 1273 K 80Mpa and for 30 minutes in a 15 mm-diameter graphite die, producing the initial bulk samples named as HD0. Subsequently, a hot deformation process was performed by repressing the HD0 samples in a larger graphite die with an inner diameter of 20 mm at 823 K for

30 min using the same stress. Finally, disk-shaped samples of 20 mm called HD*x* were obtained and *x* stand for hot deformation times.

**Structural Characterization**: The phase structure of the samples was examined over the 2*θ* range of 10-80º using an X-ray diffractometer (XRD, Empyrean, PANalytical, Netherlands) and the texture evolution were carried out by the pole figure measurement using the Schulz back-reflection method (XRD, D8 Advance, Bruker, Germany) The fractographs were determined by scanning electron microscopy (SEM, IT800-SHL, JEOL, Japan). The atomic-scale microstructures were characterized by scanning transmission electron microscopy (STEM, FEI Titan G2 60-300, FEI, USA). The specimen for STEM analysis was prepared by using a focused ion beam (FIB, Helios G4 UX, FEI, USA).

**Thermoelectric transport properties**: The electrical conductivity and Seebeck

coefficient were measured simultaneously on a commercial equipment (LSR-3, Linseis, Germany) under a high-purity helium atmosphere at a temperature range of 300-525 K. And Seebeck coefficients for BSTS-I, BSTS-PB5 and BSTS-PB220 samples were measured by using the Portable Thermoelectric Meter-3 (PTM-3, Joule Yacht) at 300 K, respectively. To ensure the accuracy, each sample was measured ten times at various locations. The thermal diffusivity (*D*) and specific heat capacity ( $C_p$ ) of BiSbTe<sub>1.5</sub>Se<sub>1.5</sub> samples were determined by laser flash apparatus ((LFA-457, Netzsch, Germany) and differential scanning calorimeter (DSC 404 F3, Netzsch, Germany) in argon flow, respectively. The carrier concentration and carrier mobility were measured under a reversible magnetic field (0.9 T) by the Van der Pauw method by using a Hall measurement system (Lake Shore 8400 Series, Model 8404, USA) at 323 K.The volume density  $(\rho)$  was measured using the Archimedes method and the thermal conductivity (*κ*) was calculated according to the equation  $\kappa = DC_p \rho$ .

#### **The preferred orientations**

The preferred orientations *F* of the (00*l*) planes for HD*x* bulk BiSbSe<sub>1.25</sub>Te<sub>1.75</sub> samples are evaluated based on the Lotgering factor<sup>[1-3]</sup> via analysis of the XRD pattern according to the following equations (1) and (2):

$$
F = (P - P_0) / (1 - P_0) \tag{S1}
$$

$$
P = \sum I(00l) / \sum I(hkl)
$$
 (S2)

#### **The single parabolic band (SPB) model**

The single parabolic band (SPB) model was adopted to calculate the relationship between Seebeck coefficient and carrier concentrations at 323 K.[4] The Seebeck coefficient and carrier concentration of a degenerate semiconductor can be expressed as followed equations:

$$
S = \frac{k_{\rm B} \left( \frac{(2+\lambda)F_{1+\lambda}(\eta)}{(1+\lambda)F_{2}(\eta)} - \eta \right)}{2}
$$
 (S3)

$$
e\left((1+\lambda)F_{\lambda}(\eta)\right)^{-\eta}\right) \tag{S4}
$$

$$
n_{\rm H} = 4\pi \left(\frac{2m^{*}kT}{h^{2}}\right)^{2} F_{1}(\eta) \tag{S5}
$$

where  $k_B$ , *e*,  $\eta$ , *h*, and  $\lambda$  is the Boltzmann constant, electron charge, chemical potential, Planck constant and phonon scattering factor ( $\lambda = 0$ ).  $F_j(\eta)$  is the Fermi integral, with *x* being the reduced carrier energy. The reduced Fermi energy *η* is determined based on the fitting of the Seebeck coefficients.

The band effective masses *m*\* in this work at 323 K is obtained by fitting experimental data into Equations S1, S2 and S3. The Lorenz number *L* can be evaluated by the following Equation S6,

$$
L = \frac{k^2 3F_0(\eta)F_2(\eta) - 2F_1(\eta)^2}{e^2 + F_0(\eta)^2}
$$
 (S6)

### **Weighted mobility**

The weighted mobility  $\mu$ <sub>W</sub> at 323 K was calculated using the measured data of *S* and the  $\sigma$  according to the following formula<sup>[5]</sup>:

$$
\mu_{\rm w} = \frac{3h^3 \sigma}{8\pi e (2m_e k_{\rm B} T)^{3/2}} \left[ \frac{\exp\left[\frac{|S|}{k_{\rm B}/e} - 2\right]}{1 + \exp\left[-5\left(\frac{|S|}{k_{\rm B}/e} - 1\right)\right]} + \frac{\frac{3}{\pi^2 k_{\rm B}/e}}{1 + \exp\left[5\left(\frac{|S|}{k_{\rm B}/e} - 1\right)\right]} \right] \tag{S7}
$$

**The dimensionless quality factor** *B*

The dimensionless quality factor B is calculated using the following relationship[6]:

$$
B = 9 \frac{\mu_{\rm w}}{\kappa_{\rm L}} \left(\frac{T}{300}\right)^{5/2} \tag{S8}
$$

Material	Operating temperature $(K)$	Type	ZΤ
$Mg_{3.2}Bi_{1.298}Sb_{0.7}Te_{0.002}^{[7]}$	350	n	0.9
$Mg_{2.475}Zn_{0.5}Li_{0.025}Sb_2^{[8]}$	350	p	0.1
$Bi_2Te_3^{[9]}$	300	n	0.65
$(Bi0.5Sb1.5Te3)0.97(MgB2)0.03[10]$	300	p	1.2
Ag $Pb_{10}SbTe_{12}^{[11]}$	300	n	0.37
$Ag_{0.83}Sb_{1.06}Te_{2}^{[12]}$	300	p	0.32
HD3	323	n	0.39

**Table S1.** Comparisons of *ZT* at low temperature for HD3 and other state-of-the-art systems.

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